

Title (en)  
ADDITIVE FOR THERMOPLASTIC RESIN AND METHOD FOR PRODUCING SAME, THERMOPLASTIC RESIN COMPOSITION, AND MOLDED ARTICLE

Title (de)  
ZUSATZSTOFF FÜR EIN THERMOPLASTISCHES HARZ, VERFAHREN ZU SEINER HERSTELLUNG, THERMOPLASTISCHE HARZZUSAMMENSETZUNG UND FORMARTIKEL

Title (fr)  
ADDITIF POUR RÉSINE THERMOPLASTIQUE ET SON PROCÉDÉ DE FABRICATION, COMPOSITION DE RÉSINE THERMOPLASTIQUE ET ARTICLE MOULÉ

Publication  
**EP 2418245 A4 20121010 (EN)**

Application  
**EP 10761459 A 20100409**

Priority  
• JP 2010002596 W 20100409  
• JP 2009095948 A 20090410  
• JP 2009226729 A 20090930

Abstract (en)  
[origin: EP2418245A1] Disclosed is an additive for a thermoplastic resin, which provides a thermoplastic resin composition excellent in formability and also provides a shaped article excellent in surface appearance and flame retardance. The additive for a thermoplastic resin comprises tetrafluoroethylene polymer (A) and alkyl methacrylate polymer (B) containing 50% by mass or more of units of alkyl methacrylate having an alkyl group with carbon numbers of 2 to 6.

IPC 8 full level  
**C08L 23/12** (2006.01); **C08L 27/18** (2006.01); **C08L 33/10** (2006.01); **C08L 53/02** (2006.01)

CPC (source: EP KR US)  
**C08F 2/22** (2013.01 - EP US); **C08F 259/08** (2013.01 - EP KR); **C08L 23/00** (2013.01 - KR); **C08L 27/18** (2013.01 - EP KR US); **C08L 33/08** (2013.01 - KR); **C08L 33/10** (2013.01 - EP US); **C08F 220/14** (2013.01 - EP US); **C08F 220/1804** (2020.02 - EP KR US); **C08F 220/1808** (2020.02 - EP US); **C08F 259/08** (2013.01 - US)

Citation (search report)  
• [X] US 3859120 A 19750107 - SCHRAMM GEORGE T  
• [X] US 7067574 B2 20060627 - TOMIHASHI NOBUYUKI [JP], et al  
• See references of WO 2010116756A1

Cited by  
EP3023441A4

Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

DOCDB simple family (publication)  
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DOCDB simple family (application)  
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